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FGD3245G2_F085 / FGB3245G2_F085

May 2014



EcoSPARK[®]2 320mJ, 450V, N-Channel Ignition IGBT

Features

■ SCIS Energy = 320mJ at T_J = 25°C

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- Logic Level Gate Drive
- Low Saturation Voltage
- Qualified to AEC Q101
- RoHS Compliant

Applications

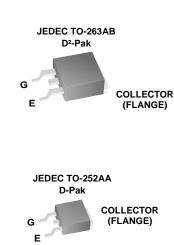
- Automotive Ignition Coil Driver Circuits
- Coil On Plug Applications

General Description

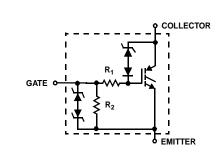
The FGB3245G2_F085 and FGD3245G2 are N-channel IGBTs designed in Fairchild's EcoSPARK-2 technology which helps in eliminating external protection circuitry. The technology is optimized for driving the coil in the harsh environment of automotive ignition systems and offers outstanding Vsat and SCIS Energy capability also at elevated operating temperatures. The logic level gate input is ESD protected and features an integrated gate resistor. An integrated zener-circuitry clamps the IGBT's collecter- to-emitter voltage at 450V which enables systems requiring a higher spark voltage



Package







Symbol	Parameter	Rating	Units
BV _{CER}	Collector to Emitter Breakdown Voltage (I _C = 1mA)	450	V
BV _{ECS}	Emitter to Collector Voltage - Reverse Battery Condition (I _C = 10mA)	28	V
E _{SCIS25}	Self Clamping Inductive Switching Energy (Note 1)	320	mJ
E _{SCIS150}	Self Clamping Inductive Switching Energy (Note 2)	180	mJ
I _{C25}	Collector Current Continuous, at V_{GE} = 4.0V, T_C = 25°C	23	А
I _{C110}	Collector Current Continuous, at V _{GE} = 4.0V, T _C = 110°C	23	А
V _{GEM}	Gate to Emitter Voltage Continuous	±10	V
D	Power Dissipation Total, at T _C = 25°C	150	W
PD	Power Dissipation Derating, for T _C > 25 ^o C	1.1	W/ºC
TJ	Operating Junction Temperature Range	-40 to +175	°C
T _{STG}	Storage Junction Temperature Range	-40 to +175	°C
TL	Max. Lead Temp. for Soldering (Leads at 1.6mm from case for 10s)	300	°C
T _{PKG}	Max. Lead Temp. for Soldering (Package Body for 10s)	260	°C
ESD	Electrostatic Discharge Voltage at100pF, 1500 Ω	4	kV
L3D	CDM-Electrostatic Discharge Voltage at 1Ω	2	kV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FGD3245G2	FGD3245G2_F085	TO252AA	330mm	16mm	2500 units
FGB3245G2	FGB3245G2_F085	TO263AB	330mm	24mm	800 units

Electrical Characteristics $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units

Off State Characteristics

-							
BV _{CER}	Collector to Emitter Breakdown Voltage	$I_{CE} = 2mA, V_{GE} = 0,$ $R_{GE} = 1K\Omega,$ $T_{J} = -40 \text{ to } 150^{\circ}\text{C}$		420	-	480	V
BV _{CES}	Collector to Emitter Breakdown Voltage	$I_{CE} = 10mA, V_{GE} = 0V,$ $R_{GE} = 0,$ $T_{J} = -40 \text{ to } 150^{\circ}\text{C}$		440	-	500	V
BV _{ECS}	Emitter to Collector Breakdown Voltage	I_{CE} = -75mA, V_{GE} = 0V, T _J = 25°C		28	-	-	V
BV _{GES}	Gate to Emitter Breakdown Voltage	I _{GES} = ±2mA		±12	±14	-	V
1	Collector to Emitter Leakage Current	V _{CE} = 250V, R _{GE} = 1KΩ	T _J = 25°C	-	-	25	μA
ICER			T _J = 150 ^o C	-	-	1	mA
	Emitter to Collector Leokone Current	V _{EC} = 24V,	T _J = 25°C	-	-	1	mA
IECS	Emitter to Collector Leakage Current		T _J = 150 ^o C	-	-	40	ША
R ₁	Series Gate Resistance		•	-	120	-	Ω
R ₂	Gate to Emitter Resistance			10K	-	30K	Ω

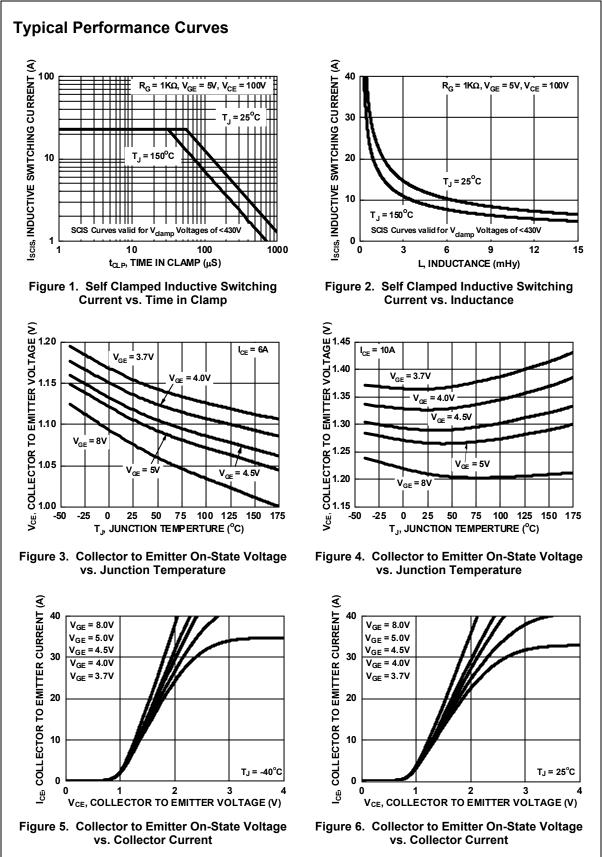
On State Characteristics

V _{CE(SAT)}	Collector to Emitter Saturation Voltage	$I_{CE} = 6A, V_{GE} = 4V,$	$T_J = 25^{\circ}C$	-	1.13	1.25	V
V _{CE(SAT)}	Collector to Emitter Saturation Voltage	I _{CE} = 10A, V _{GE} = 4.5V,	T _J = 150 ^o C	-	1.32	1.50	V
V _{CE(SAT)}	Collector to Emitter Saturation Voltage	$I_{CE} = 15A, V_{GE} = 4.5V,$	T _J = 150 ^o C	-	1.64	1.85	V

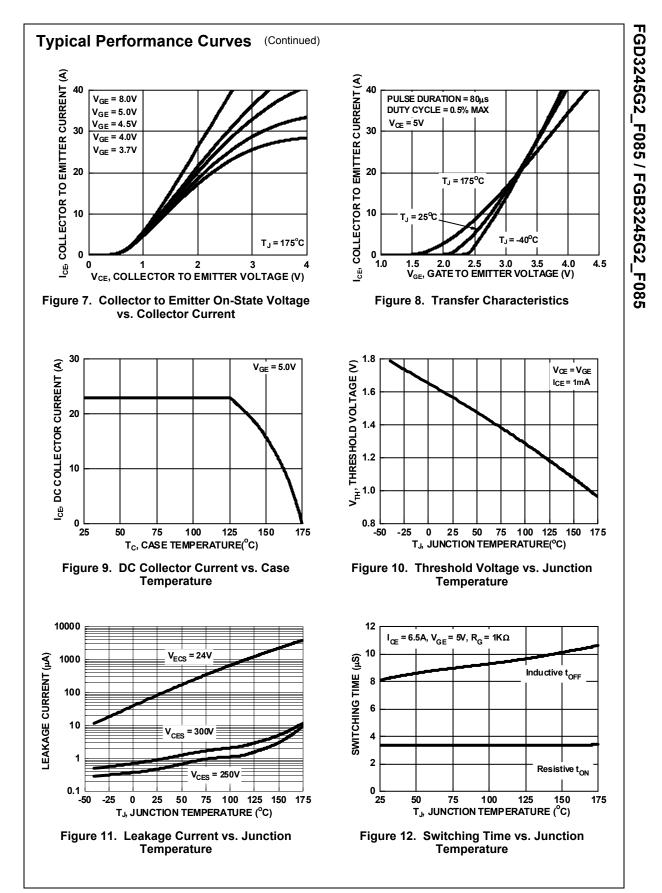
Symbol	Parameter	Test Conditions		Min	Тур	Мах	Units
Dynami	ic Characteristics						
Q _{G(ON)}	Gate Charge	I _{CE} = 10A, V _{CE} = 12V, V _{GE} = 5V		-	23	-	nC
Varatio	Gate to Emitter Threshold Voltage	$h = mitter hreshold 0 tage = 1 m A V_{a} = V_{a}$	$T_{J} = 25^{\circ}C$	1.3	1.6	2.2	v
V _{GE(TH)}	Gale to Emilier Threshold Voltage		T _J = 150 ^o C	0.75	1.1	1.8	v
V _{GEP}	Gate to Emitter Plateau Voltage	V _{CE} = 12V, I _{CE} = 10A		-	2.7	-	V
Switchi t _{d(ON)R}	ng Characteristics Current Turn-On Delay Time-Resistive	V _{CE} = 14V, R _L = 1Ω		-	0.9	4	μS
t _{rR}	Current Rise Time-Resistive	$V_{GE} = 5V, R_G = 1K\Omega$ T ₁ = 25°C,		-	2.6	7	μS
t _{d(OFF)L}	Current Turn-Off Delay Time-Inductive	V _{CE} = 300V, L = 1mH,		-	5.4	15	μS
t _{fL}	Current Fall Time-Inductive	V _{GE} = 5V, R _G = 1KΩ I _{CE} = 6.5A, T _J = 25°C,		-	2.7	15	μS
E _{SCIS}	Self Clamped Inductive Switching	L = 3.0 mHy,RG = 1KΩ, VGE = 5V, (Note 1)	TJ = 25°C	-	-	320	mJ

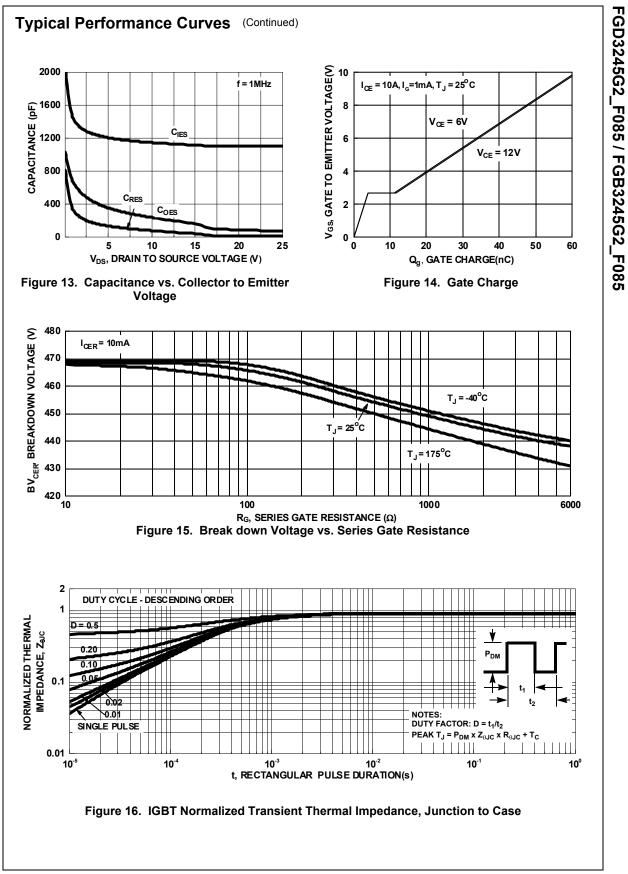
Notes:

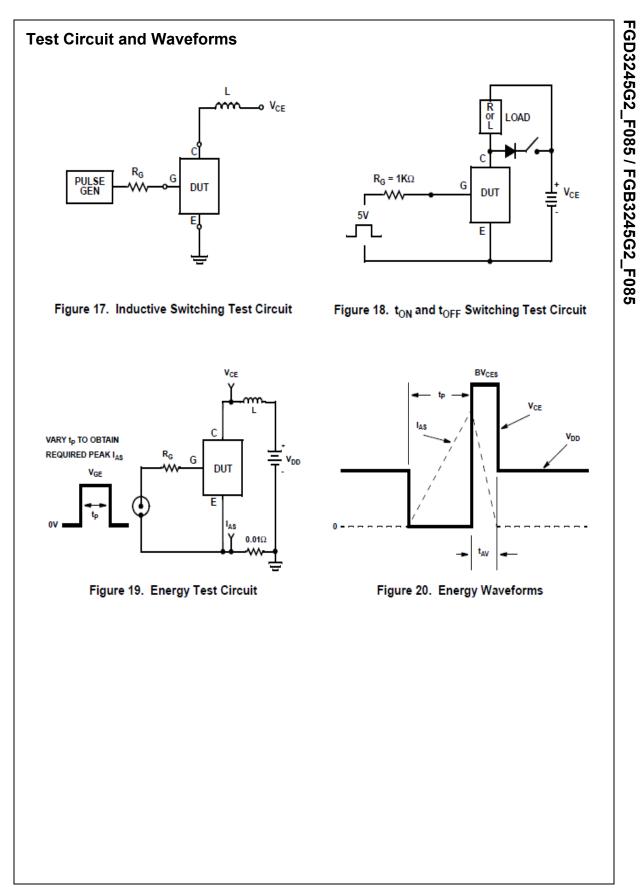
1: Self Clamping Inductive Switching Energy (E_{SCIS25}) of 320 mJ is based on the test conditions that starting Tj=25^oC; L=3mHy, I_{SCIS}=14.6A,V_{CC}=100V during inductor charging and V_{CC}=0V during the time in clamp. 2: Self Clamping Inductive Switching Energy ($E_{SCIS150}$) of 180 mJ is based on the test conditions that starting Tj=150^oC; L=3mHy, I_{SCIS}=10.9A,V_{CC}=100V during inductor charging and V_{CC}=0V during the time in clamp.

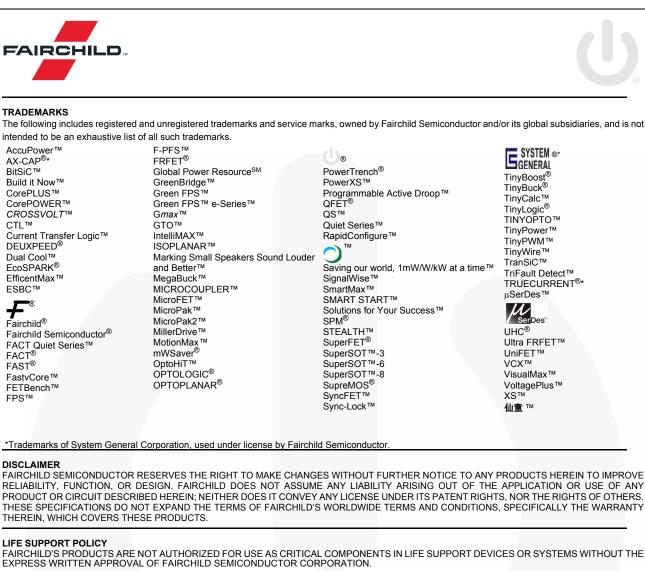


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- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
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